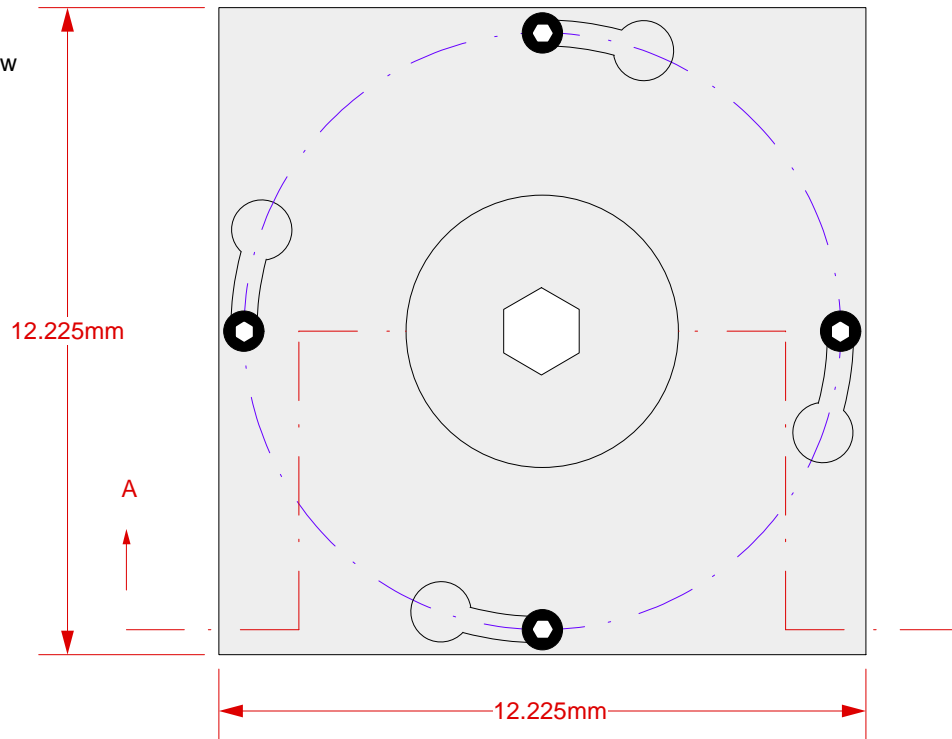


# GHz MLF Socket - Direct mount, solderless

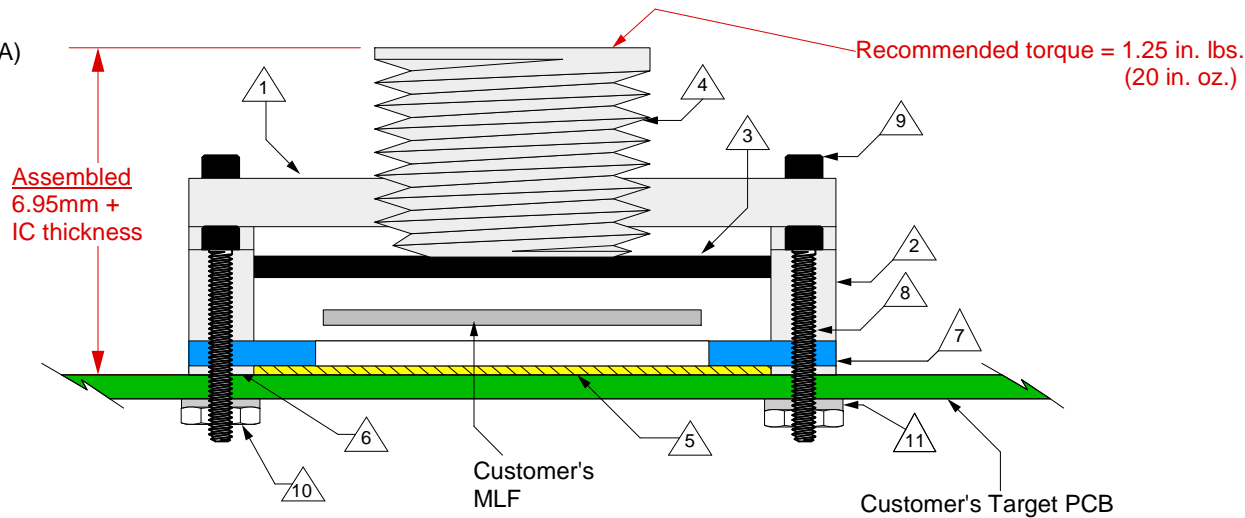
Top View



## Features

- Directly mounts to target PCB (needs tooling holes) with hardware.
- High speed, reliable Elastomer connection
- Minimum real estate required
- Compression plate distributes forces evenly
- IC guide prevents over compression of elastomer
- Easily removable swivel socket lid

Side View  
(Section AA)



- △ 1 Socket Lid: Black anodized Aluminum. Thickness = 2.5mm.
- △ 2 Socket base: Black anodized Aluminum. Thickness = 3mm.
- △ 3 Compression Plate: Black anodized Aluminum. Thickness = 1.5mm.
- △ 4 Compression screw: Clear anodized Aluminum. Thickness = 5mm, Hex socket = 3mm.
- △ 5 Elastomer: 20 micron dia gold plated brass filaments arranged symmetrically in a silicone rubber (63.5 degree angle). Thickness = 0.5mm.
- △ 6 Elastomer Guide: Cirlex Thickness = 0.475mm.
- △ 7 IC (MLF) Guide: Torlon
- △ 8 Socket base screw: Socket head cap, Alloy steel with black oxide finish, 0-80 fine thread, 9.525mm long.
- △ 9 Socket lid screw: Shoulder screw, 18-8 SS, 0-80 fine thread.
- △ 10 Socket base nut: 18-8 Stainless steel, 0-80 fine thread.
- △ 11 Nylon washer: 1.73mm ID; 4.78mm OD 0.64mm thickness.

## SG-MLF-7006 Drawing

Status: Released

Scale: -

Rev: K



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Drawing: H. Hansen

Date: 10/22/02

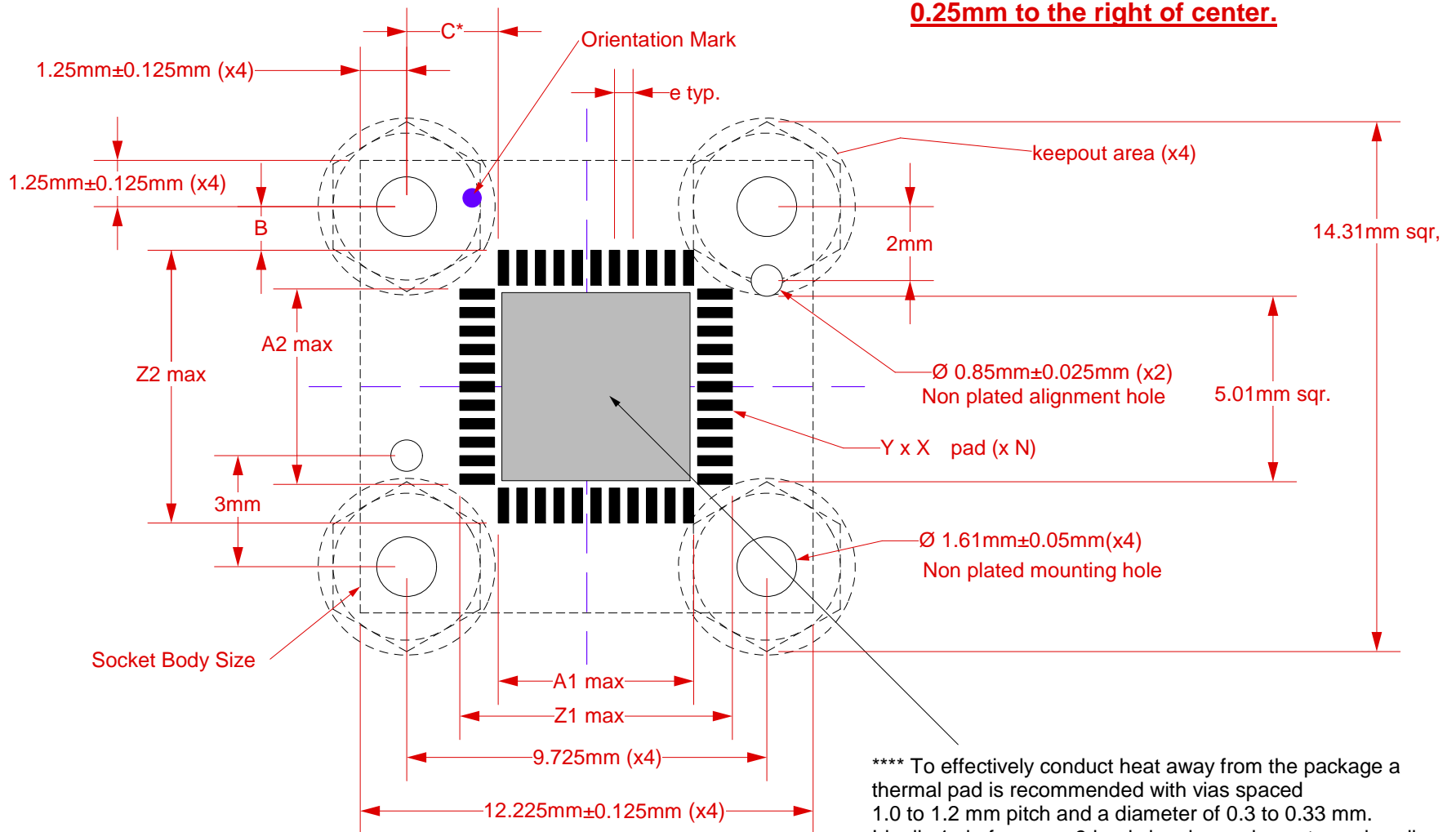
File: SG-MLF-7006 Dwg.mcd

Modified: 05/07/14, DH

All tolerances:  $\pm 0.125$ mm (unless stated otherwise). Materials and specifications are subject to change without notice.

Recommended PCB Layout  
Top View


**\*Note: MLF pattern is not symmetrical with respect to the mounting holes. It is offset 0.25mm to the right of center.**



Target PCB Recommendations

Total thickness: 1.6mm min.  
Plating: Gold or Solder finish  
PCB Pad height: Same or higher than solder mask

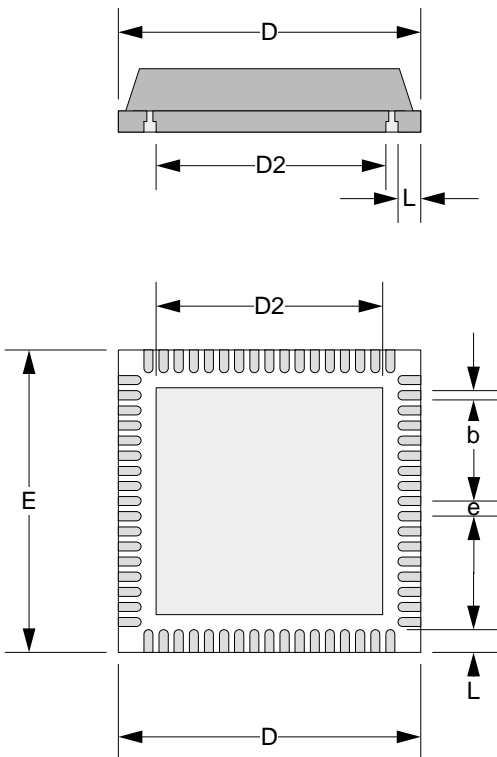
NOTE: Steel backing plate may be required based on end user's application

	<b>SG-MLF-7006 Drawing</b>	Status: Released	Scale: 3:1	Rev: k
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		File: SG-MLF-7006 Dwg.mcd	Modified: 05/07/14, DH	

Package Code	C	B	Z1max	A1max	Z2max	A2 max	e	X	Y	N	Thermal Pad Recommendations
MLF44B	2.47	1.18	7.36	5.28	7.36	5.28	0.5	0.28	0.94	44	5.08 x 5.08
MLF48A	2.22	1.18	7.36	5.78	7.36	5.78	0.5	0.28	0.69	48	5.08 x 5.08
MLF32B	2.65	1.18	7.36	4.92	7.36	4.92	0.65	0.37	1.06	32	4.84 x 4.84
MLF28C	2.5	1.18	7.36	5.22	7.36	5.22	0.8	0.42	0.97	28	5.02 x 5.02
MLF56B	2.41	1.18	7.36	5.4	7.36	5.4	0.4	0.2	0.69	56	5.5 x 5.5

Recommended PCB Layout Tolerances:  $\pm 0.025\text{mm}$  unless stated otherwise.

All dimensions are in mm.



Package Code	e	D min	D max	E min	E max	b min	b max	L min	L max	D2	N
MLF44B	0.5	6.85	7.15	6.85	7.15	0.18	0.3	0.5	0.75	5.18	44
MLF48A	0.5	6.85	7.15	6.85	7.15	0.18	0.3	0.3	0.5	5.68	48
MLF32B	0.65	6.85	7.15	6.85	7.15	0.23	0.35	0.5	0.75	4.94	32
MLF28C	0.8	6.85	7.15	6.85	7.15	0.28	4	5	0.75	5.12	28
MLF56B	0.4	6.85	7.15	6.85	7.15	0.15	0.25	0.3	0.5	3.8	56

**SG-MLF-7006 Drawing**

Status: Released

Scale: 3:1

Rev: k



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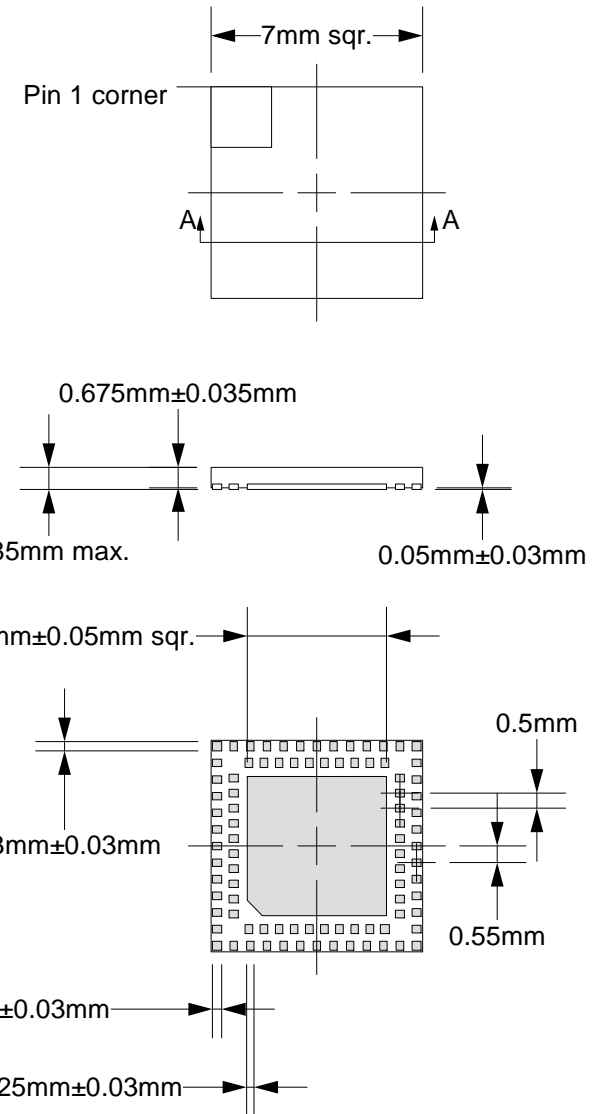
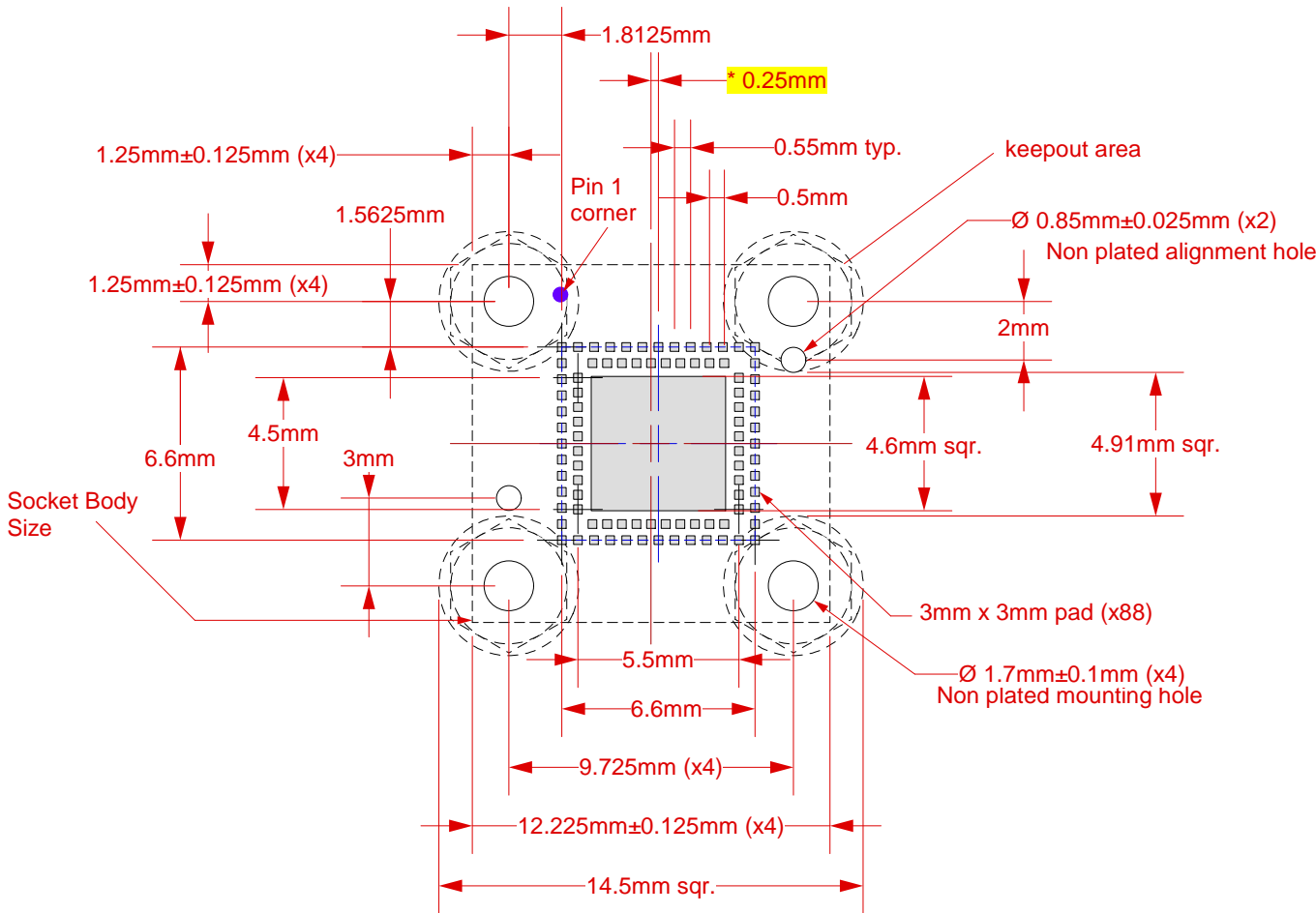
File: SG-MLF-7006 Dwg.mcd

Modified: 05/07/14, DH

**\*Note: MLF pattern is not symmetrical with respect to the mounting holes. It is offset 0.25mm to the right of center.**


Compatible AQFN88 IC

AQFN88



**Target PCB Recommendations**  
 Total thickness: 1.6mm min.  
 Plating: Gold or Solder finish  
 PCB Pad height: Same or higher than solder mask

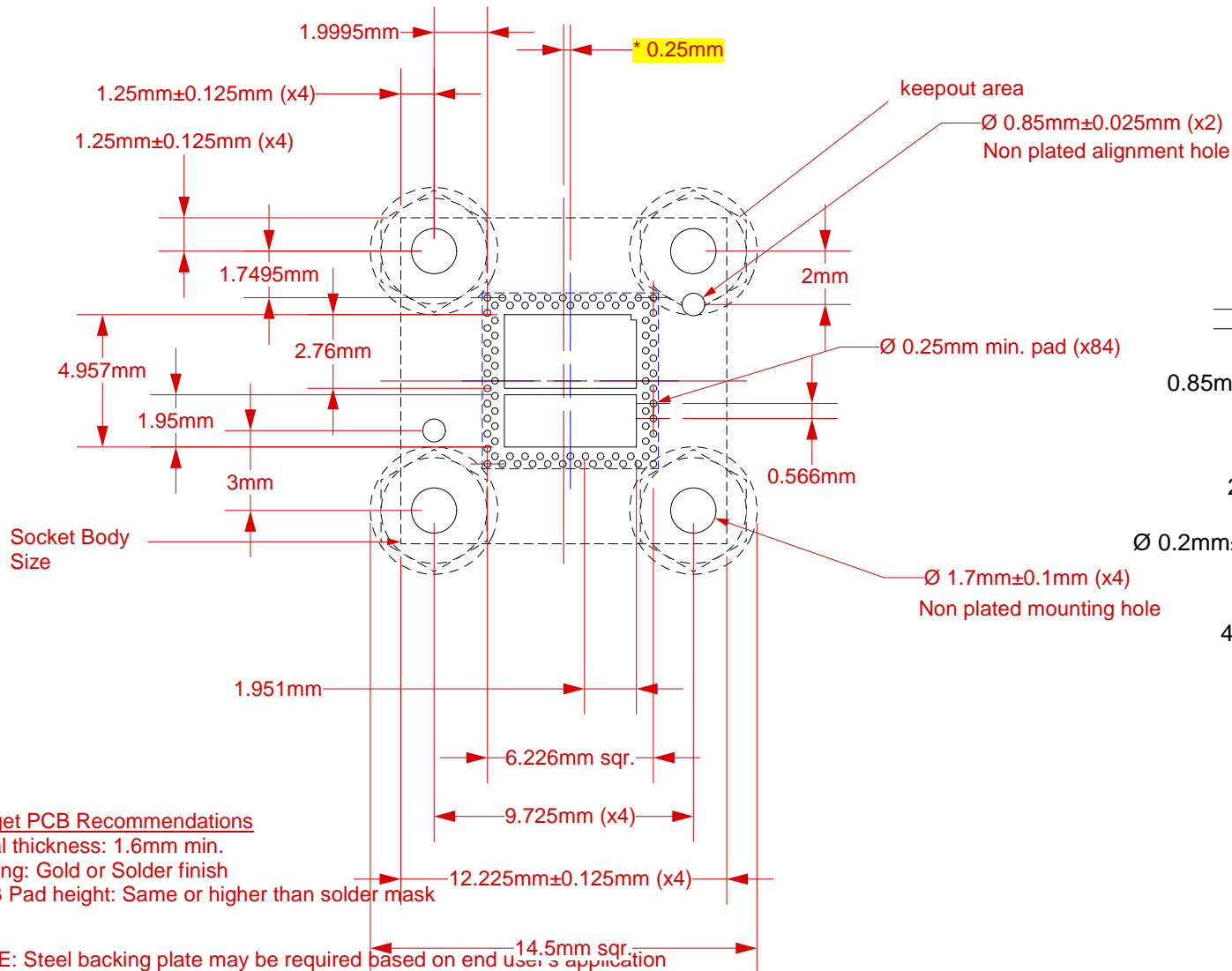
NOTE: Steel backing plate may be required based on end user's application

	<b>SG-MLF-7006 Drawing</b>	Status: Released	Scale: 4:1	Rev: K
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		File: SG-MLF-7006 Dwg.mcd	Modified: 05/07/14, DH	

**\*Note: aQFN pattern is not symmetrical with respect to the mounting holes. It is offset 0.25mm.**

Compatible AQFN88 IC

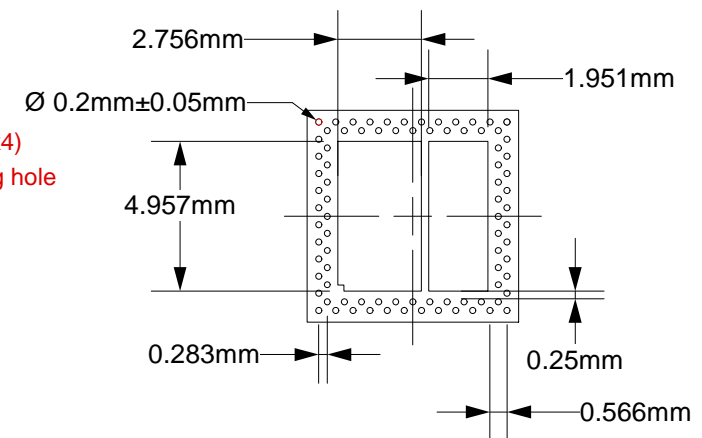
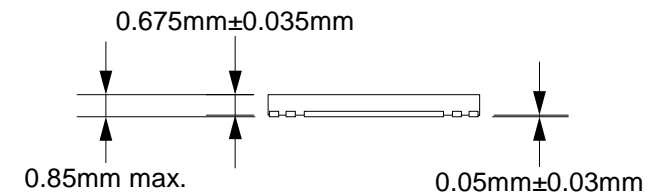
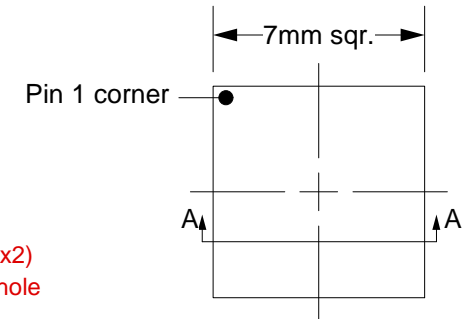
AQFN84




Target PCB Recommendations

Total thickness: 1.6mm min.  
Plating: Gold or Solder finish  
PCB Pad height: Same or higher than solder mask

NOTE: Steel backing plate may be required based on end user's application



	<b>SG-MLF-7006 Drawing</b>	Status: Released	Scale: 4:1	Rev: K
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